MOSFET - Power, Single, P-Channel, TO-220

-60 V, -12 A

Features

- Low R_{DS(on)}
- Rugged Performance
- Fast Switching
- These are Pb-Free Devices*

Applications

- Industrial
- Automotive
- Power Supplies

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parame	Symbol	Value	Unit		
Drain-to-Source Voltage	V_{DSS}	-60	V		
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady	T _C = 25°C	I _D	-12	Α
Current (Note 1)	State	T _C = 85°C		-9.0	
Power Dissipation (Note 1)		T _C = 25°C	P _D	62.5	W
Continuous Drain	Steady State	T _A = 25°C	I _D	-2.4	Α
Current (Note 1)	State	T _A = 85°C		-1.8	
Power Dissipation (Note 1)		T _A = 25°C	P _D	2.4	W
Pulsed Drain Current	t _p =	:10 μs	I _{DM}	-42	Α
Operating Junction and S	T _J , T _{STG}	-55 to 175	°C		
Source Current (Body Dio	Is	-12	Α		
Single Pulse Drain-to-So Energy (V _{DD} = -30 V, I _{PK} = -12 A, L = 3.0 m	EAS	216	mJ		
Lead Temperature for Solo (1/8" from case for 10	T _L	260	°C		

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Case	$R_{\theta JC}$	2.4	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	62.5	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

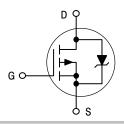


ON Semiconductor®

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V _{(BR)DSS}	R _{DS(on)} Typ	I _D MAX	
-60 V	156 mΩ @ –10 V	-12 A	

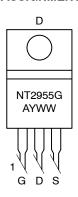
P-Channel



MARKING DIAGRAM & PIN ASSIGNMENT



TO-220 CASE 221A STYLE 5



= Assembly Location

= Year WW = Work Week = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping		
NTP2955G	TO-220 (Pb-Free)	50 Units / Rail		

1. When surface mounted to an FR4 board using 1 in pad size (Cu. area = 1.127 in sq [1 oz] including traces).

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS (T_J=25°C unless otherwise stated)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS			<u>.</u>		•		L
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		-60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				67		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25°C			-1.0	μА
		$V_{DS} = -48 \text{ V}$	T _J = 125°C			-10	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{C}$	_{SS} = ±20 V			±100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D}$	= -250 μA	-2.0		-4.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				56		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = -10 V,	I _D = -12 A		156	196	mΩ
Forward Transconductance	g _{FS}	$V_{DS} = -60 \text{ V},$	I _D = -12 A		6.0		S
CHARGES AND CAPACITANCES					1		II.
Input Capacitance	C _{ISS}				507	700	pF
Output Capacitance	C _{OSS}	$V_{GS} = 0 \text{ V, f} = V_{DS} = -$			150	250	
Reverse Transfer Capacitance	C _{RSS}	• 03 –			48	98	
Total Gate Charge	Q _{G(TOT)}				14		nC
Threshold Gate Charge	Q _{G(TH)}	$V_{GS} = -10 \text{ V}, V_{DS} = -48 \text{ V},$ $I_D = -12 \text{ A}$			1.6	2.5	
Gate-to-Source Charge	Q_{GS}				3.4		
Gate-to-Drain Charge	Q_{GD}				6.2		7
SWITCHING CHARACTERISTICS (No	ote 3)		<u>.</u>				•
Turn-On Delay Time	t _{d(on)}				10	20	ns
Rise Time	t _r	V _{GS} = -10 V, V	_{DD} = -30 V,		41	80	
Turn-Off Delay Time	t _{d(off)}	$I_{D} = -12 \text{A}, \text{R}$	$I_G = 9.1 \Omega$		27	47	
Fall Time	t _f				45	85	
DRAIN-SOURCE DIODE CHARACTE	RISTICS		<u>.</u>				•
Forward Diode Voltage	V_{SD}	V _{GS} = 0 V,	T _J = 25°C		-1.6	-2.0	V
		$I_S = -12 \text{ A}$	T _J = 125°C		-1.36		
Reverse Recovery Time	t _{RR}				53		
Charge Time	ta	$V_{GS} = 0 \text{ V, } dI_{S}/dt = 100 \text{ A/}\mu\text{s,}$ $I_{S} = -12 \text{ A}$			42		ns
Discharge Time	t _b				12		
Reverse Recovery Charge	Q _{RR}				126		nC

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.

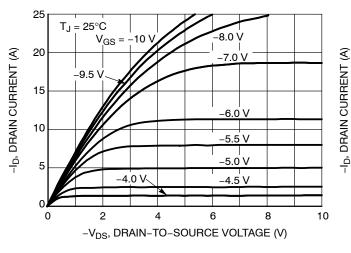


Figure 1. On-Region Characteristics

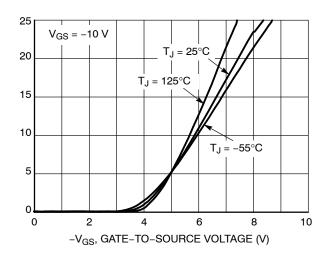


Figure 2. Transfer Characteristics

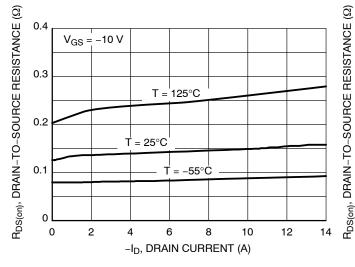


Figure 3. On-Resistance versus Drain Current and Temperature

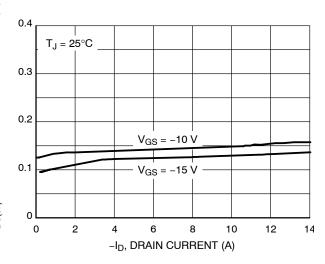


Figure 4. On-Resistance versus Drain Current and Gate Voltage

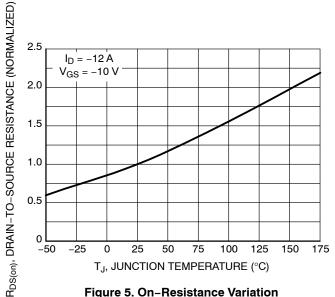


Figure 5. On–Resistance Variation with Temperature

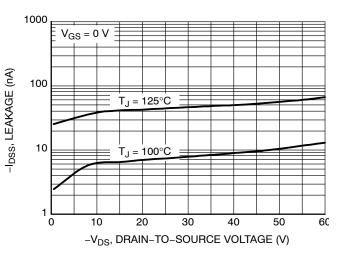
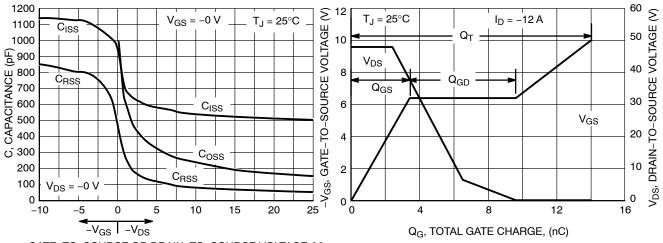


Figure 6. Drain-to-Source Leakage versus Voltage



GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (V)

Figure 7. Capacitance Variation

Figure 8. Gate-to-Source and Drain-to-Source Voltage versus Total Charge

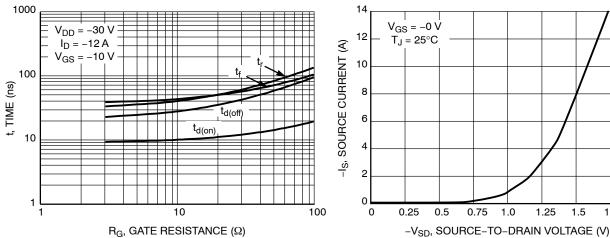


Figure 9. Resistive Switching Time Variation versus Gate Resistance

Figure 10. Diode Forward Voltage versus Current

1.0

1.25

1.75

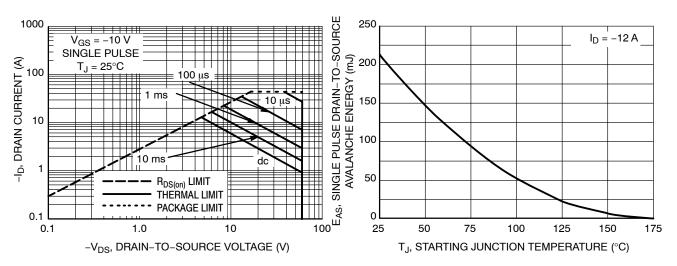
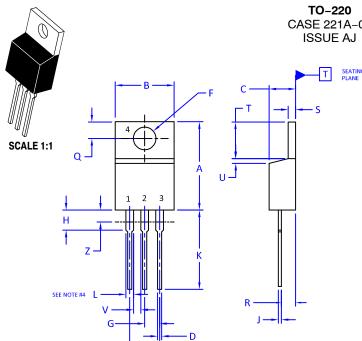


Figure 11. Maximum Rated Forward Biased **Safe Operating Area**

Figure 12. Maximum Avalanche Energy versus Starting Junction Temperature

MECHANICAL CASE OUTLINE



CASE 221A-09

DATE 05 NOV 2019

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: INCHES
- 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

4. MAX WIDTH FOR F102 DEVICE = 1.35MM

	INCH	HES	MILLIMETERS		
DIM	MIN.	MAX.	MIN.	MAX.	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.415	9.66	10.53	
С	0.160	0.190	4.07	4.83	
D	0.025	0.038	0.64	0.96	
F	0.142	0.161	3.60	4.09	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.161	2.80	4.10	
J	0.014	0.024	0.36	0.61	
К	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
N	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.41	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
V	0.045		1.15		
Z		0.080		2.04	

STYLE 1:		STYLE 2:		STYLE 3:		STYLE 4:	
PIN 1.	BASE	PIN 1.	BASE	PIN 1.	CATHODE	PIN 1.	MAIN TERMINAL 1
2.	COLLECTOR	2.	EMITTER	2.	ANODE	2.	MAIN TERMINAL 2
3.	EMITTER	3.	COLLECTOR	3.	GATE	3.	GATE
4.	COLLECTOR	4.	EMITTER	4.	ANODE	4.	MAIN TERMINAL 2
STYLE 5:		STYLE 6:		STYLE 7:		STYLE 8:	
PIN 1.	GATE	PIN 1.	ANODE	PIN 1.	CATHODE	PIN 1.	CATHODE
2.	DRAIN	2.	CATHODE	2.	ANODE	2.	ANODE
3.	SOURCE	3.	ANODE	3.	CATHODE	3.	EXTERNAL TRIP/DELAY
4.	DRAIN	4.	CATHODE	4.	ANODE	4.	ANODE
STYLE 9:		STYLE 10:		STYLE 11	:	STYLE 12	:
PIN 1.	GATE	PIN 1.	GATE	PIN 1.	DRAIN	PIN 1.	MAIN TERMINAL 1
2.	COLLECTOR	2.	SOURCE	2.	SOURCE	2.	MAIN TERMINAL 2
3.	EMITTER	3.	DRAIN	3.	GATE	3.	GATE
4.	COLLECTOR	4.	SOURCE	4.	SOURCE	4.	NOT CONNECTED

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